	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	3	du near chien-chih.in.	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 16:15
2	BRS	L2	1()	pittkoun near saysamone.in.	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 16:16
3	BRS	L3	1927	438/257.ccls.	US- PGPUB ; USPAT	2005/01/0 3 17:04

	Type	L#	Hits	Search Text	DBs	Time Stamp
4.	BRS	${ m L4}$	164	3 and (sacrificial)	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 17:07
5	BRS	L6	292	(sacrificial near layer) near25 (mask or har-dmask) near25 (substrate)	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 17:08
6	BRS	L5	295	(sacrificial near layer) near25 (mask or hardmask) near25 (substrate)	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 17:25

	Туре	L #	Hits	Search Text	DBs	Time Stamp
7	BRS	L7		layer) near25 (mask or hardmask or hard-mask or hard near mask) near25 (substrate)	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 17:29
8	BRS	L8	6149	(sacrificial near layer or silicon near nitride or sin) near25 (mask or hardmask or hard-mask or hard near mask) near25	US- PGPUB; USPAT; EPO;	2005/01/0 3 17:47
9	BRS	L9	1374	layer or silicon near nitride or sin) near25 (mask or hardmask or	US- PGPUB ; USPAT ; EPO:	2005/01/0 3 17:31

	Type	L#	Hits	Search Text	DBs	Time Stamp
10	BRS	L10	334	hard-mask or hard near mask) near25	; EPO;	2005/01/0 3 17:38
11	BRS	L11	14 1 4 6	(pattern\$3) near3 (mask or hardmask or hard-mask or hard near mask) near25 (substrate) near25 (remov\$3)	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 17:38
12	BRS	L12	507	hard-mask or hard near mask) near25 (substrate) near25 (remov\$3) near25	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 17:39

	Type	L #	Hits	Search Text	DBs	Time Stamp
13	BRS	L13	292	(sacrificial near layer) near25 (mask) near25 (substrate)	US- PGPUB ; USPAT ; EPO; DERWE NT; IBM_T DB	2005/01/0 3 17:52
14	BRS	L14		(pattern\$3 or etch\$3) near5 (sacrificial near layer) near25 (mask) near25 (substrate)	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 17:58
15	BRS	L15		(pattern\$3 or etch\$3) near5 (silicon near nitride or sin) near25 (mask) near25 (substrate)	US- PGPUB ; USPAT ;	2005/01/0 3 17:54

	Type	L #	Hits	Search Text	DBs	Time Stamp
16	BRS	L16	2186	(pattern\$3 or etch\$3) near5 (silicon near	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 17:54
17	BRS	L17	0	near25 (substrate) near25 (tunnel near dielectric)	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 17:55
18	BRS	L18	11	near5 (silicon near	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 17:56

	Туре	L#	Hits	Search Text	DBs	Time Stamp
19	BRS	L19	3	near5 (sin) near25 (mask) near25 (substrate) near25 (tunnel\$3)	IH: P() •	2005/01/0 3 17:57
20	BRS	L20		(pattern\$3 or etch\$3) near5 (sacrificial) near25 (mask) near25 (substrate) near25 (tunnel\$3)	US- PGPUB ; USPAT ; EPO; JPO; DERWE NT; IBM_T DB	2005/01/0 3 17:57
21	BRS	L21	11 / 1 ()	(pattern\$3 or etch\$3) near5 (sacrificial near layer) near25 (substrate)	US- PGPUB ; USPAT ; EPO; DERWE NT; IBM_T DB	2005/01/0 3 17:58

	U	1	Document ID	Title	Current OR
1			20040070021	Flash memory array with increased coupling between floating and control gates	257/314
2			US 20040029389 д1	Method of forming shallow trench isolation structure with self-aligned floating gate	438/694
3	•		US 20030011025 A1	Nonvolatile semiconductor memory device and manufacturing method thereof	257/316
4				Semiconductor device and method of manufacturing the same	
5			US 6706601 B1	Method of forming tiny silicon nitride spacer for flash EPROM by using dry+wet etching technology	438/266
6		ì	$\Pi S = 6649965$	Semiconductor device and method of manufacturing the same	
7			US 6057580 A	Semiconductor memory device having shallow trench isolation structure	257/396

	U	1	Document :	ID	Title	Current	OR
8			US 6034393	A	Nonvolatile semiconductor memory device using trench isolation and manufacturing method thereof	257/315	
9			US 6027972	A	Method for producing very small structural widths on a semiconductor substrate	438/257	
10			TW 550738 .	A	Method of forming shallow trench isolation structure with self-aligned floating gate		
11			TW 466756	A	PASTT memory cell of NAND type flash memory with small feature size and high program speed		

	บ	1	Document ID	Title	Current OR
1				Method of manufacturing SONOS flash memory device	438/666
2				Methods for fabricating nonvolatile memory devices	438/594
3				Methods of manufacturing and-type flash memory devices	438/257
4			1/(1()/2())(1///////////////////////////	Method of making nanoscopic tunnel	438/1
5			US	Defining an isolated magnetic region in film stack for fabricating magneto-resistive random access memory device, by forming mask defining protected and unprotected regions, and performing high-temperature etch of unprotected regions	